



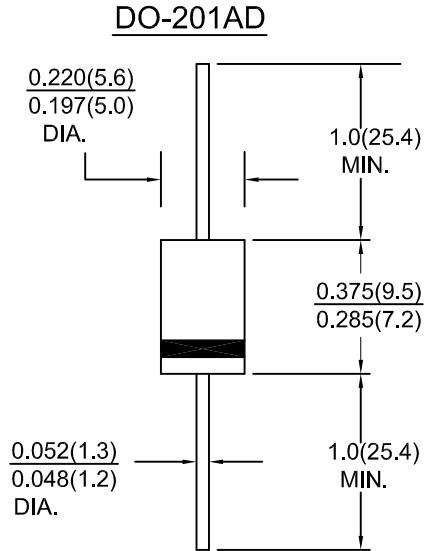
SUPER FAST RECOVERY SILICON RECTIFIERS

FEATURES:

- Low forward voltage drop
- High current capability
- High reliability
- High surge current capability
- Good for switching mode application
- Open junction

MECHANICAL DATA

Case : Molded plastic
 Epoxy: UL 94V-0 rate flame retardant
 Lead : Axial leads, solderable per MIL-STD-202,
 Method 208 guaranteed
 Polarity : Color band denotes cathode end
 Mounting Position : Any
 Weight : 1.10 grams



Dimensions in inches and (millimeters)

MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Rating at 25 °C ambient temp. unless otherwise specified.
 Single phase, half sine wave, 60 Hz, resistive or inductive load.
 For capacitive load, derate current by 20 %.

Characteristic	Symbol	SF 51	SF 52	SF 53	SF 54	SF 55	SF 56	SF 57	Units	
Maximum recurrent peak reverse voltage	VRRM	50	100	150	200	300	400	600	Volts	
Maximum RMS voltage	VRMS	35	70	105	140	210	280	420	Volts	
Maximum DC blocking voltage	VDC	50	100	150	200	300	400	600	Volts	
Maximum average forward rectified current .375"(9.5mm) lead length at Ta=55 °C	I(AV)	5.0							Amps	
Peak forward surge current ,8.3ms single half sine-wave superimposed on rated load(JEDEC Method)	IFSM	150							Amps	
Maximum instantaneous forward voltage at 5.0 A	VF	1.00			1.30		1.70		Volts	
Maximum DC reverse current at rated DC blocking voltage Ta=25 °C Ta=100 °C	IR	5.0			100				μ A	
Maximum reverse recovery time (note 1)	trr	35								nS
Typical junction capacitance (note 2)	Cj	50								pF
Operating and storage temperature range	Tj, Tstg	-65 to +150							°C	

Notes : 1. Reverse recovery test condition : I F=0.5A ; IR=1.0A ; IRR=0.25A
 2. Measured 1MHz and applied reverse voltage of 4.0V DC



RATINGS AND CHARACTERISTIC CURVES

FIG.1-TEST CIRCUIT DIAGRAM AND REVERSE RECOVERY TIME CHARACTERISTIC

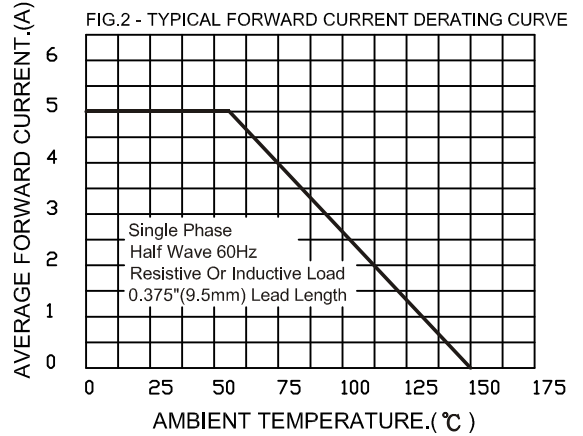
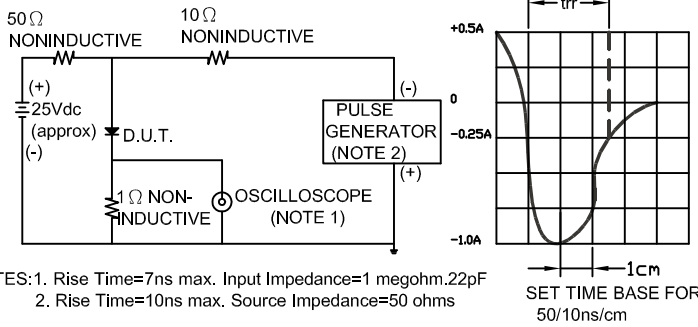


FIG.3-TYPICAL FORWARD CHARACTERISTICS

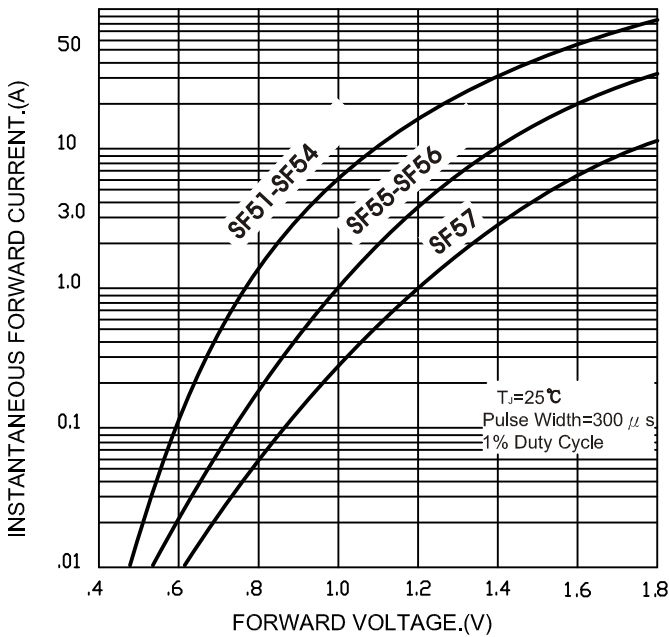


FIG.4-TYPICAL REVERSE CHARACTERISTICS

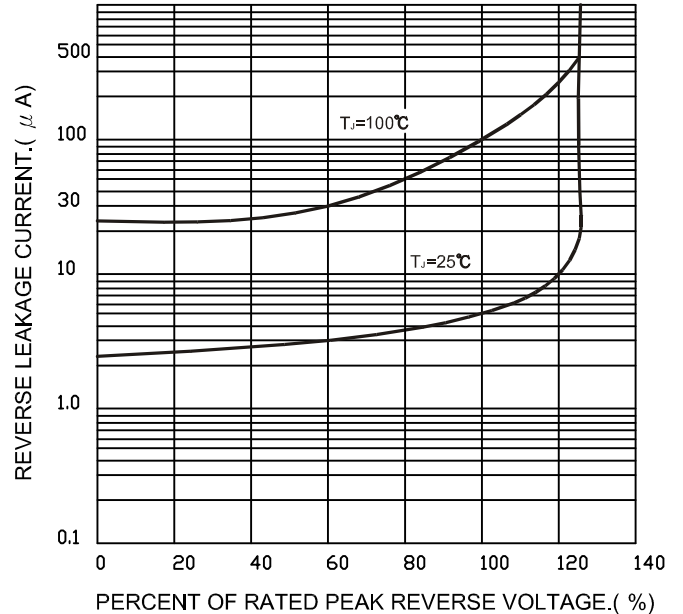


FIG.5-MAXIMUM NON-REPETITIVE FORWARD SURGE CURRENT

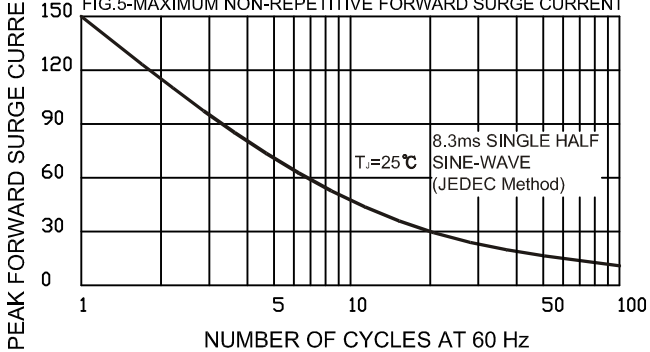
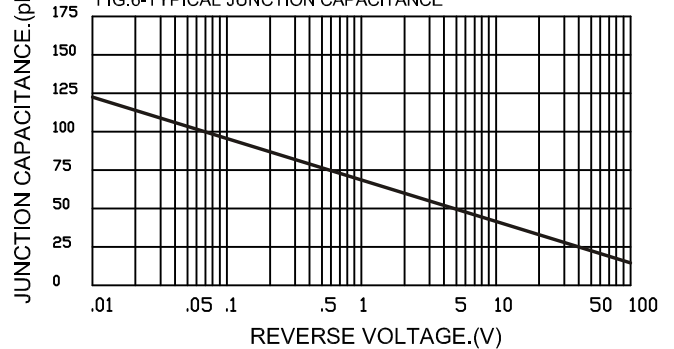


FIG.6-TYPICAL JUNCTION CAPACITANCE





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